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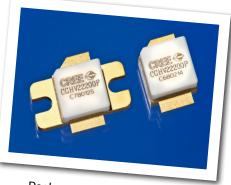
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





CGHV22200 200 W, 1800-2200 MHz, GaN HEMT for LTE

Cree's CGHV22200 is a gallium nitride (GaN) high electron mobility transistor (HEMT) is designed specifically for high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV22200F ideal for 1.8 - 2.2 GHz LTE, 4G Telecom and BWA amplifier applications. The transistor is input matched and supplied in a ceramic/ metal flange package.



Package Type: 440162 and 440161 PN: CGHV22200F and CGHV22200P

Typical Performance Over 1.8 - 2.2 GHz ($T_c = 25^{\circ}c$) of Demonstration Amplifier

Parameter	1.8 GHz	2.0 GHz	2.2 GHz	Units
Gain @ 47 dBm	16.6	19.2	18.1	dB
ACLR @ 47 dBm	-37.4	-37.4	-35.6	dBc
Drain Efficiency @ 47 dBm	31.5	31.9	34.8	%

Note:

Measured in the CGHV22200-AMP amplifier circuit, under WCDMA 3GPP test model 1, 64 DPCH, 45% clipping, PAR = 7.5 dB @ 0.01% Probability on CCDF. I_{ps} = 1.0 A

Features

- 1.8 2.2 GHz Operation
- 18 dB Gain
- -35 dBc ACLR at 50 W P_{AVE}
- 31-35 % Efficiency at 50 W P_{AVE}
- High Degree of DPD Correction Can be Applied





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Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V _{DSS}	125	Volts	25°C
Gate-to-Source Voltage	V _{GS}	-10, +2	Volts	25°C
Storage Temperature	T _{stg}	-65, +150	°C	
Operating Junction Temperature ³	Tj	225	°C	
Maximum Forward Gate Current	I _{gmax}	32	mA	25°C
Maximum Drain Current ¹	I _{dmax}	12	А	25°C
Soldering Temperature ²	Τ _s	245	°C	
Screw Torque	τ	80	in-oz	
Thermal Resistance, Junction to Case ³	R _{eJc}	1.22	°C/W	85°C, P _{DISS} = 96 W
Thermal Resistance, Junction to Case ⁴	$R_{_{ ext{ ext{ heta}JC}}}$	1.54	°C/W	85°C, P _{DISS} = 96 W
Case Operating Temperature ⁵	T _c	-40, +150	°C	

Note:

¹ Current limit for long term, reliable operation.

² Refer to the Application Note on soldering at <u>http://www.cree.com/rf/document-library</u>

³ Measured for the CGHV22200P

⁴ Measured for the CGHV22200F

⁵ See also, the Power Dissipation De-rating Curve on Page 6.

Electrical Characteristics ($T_c = 25^{\circ}C$)

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics ¹						
Gate Threshold Voltage	$V_{\rm GS(th)}$	-3.8	-3.0	-2.3	V _{DC}	$V_{_{DS}}$ = 10 V, I $_{_{D}}$ = 32 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V _{DC}	$V_{\rm DS}$ = 50 V, I _D = 1.0 A
Saturated Drain Current ²	I _{DS}	24	28.8	-	А	$V_{\rm DS}$ = 6.0 V, $V_{\rm GS}$ = 2.0 V
Drain-Source Breakdown Voltage	V _{BR}	150	-	-	V _{DC}	$V_{_{ m GS}}$ = -8 V, I $_{_{ m D}}$ = 32 mA
RF Characteristics ³ ($T_c = 25^{\circ}C$, $F_0 = 2.17$ G	Hz unless otherv	vise noted)				
Saturated Output Power ^{3,4}	P _{SAT}	-	240	-	W	V _{DD} = 50 V, I _{DQ} = 1.0 A
Pulsed Drain Efficiency ³	η	-	65	-	%	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 1.0 A, $P_{_{OUT}}$ = $P_{_{SAT}}$
Gain ⁶	G	-	18.0	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 1.0 A, $P_{_{OUT}}$ = 47 dBm
WCDMA Linearity ⁶	ACLR	-	-36.7	-	dBc	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 1.0 A, $P_{_{OUT}}$ = 47 dBm
Drain Efficiency ⁶	η	-	34.5	-	%	$V_{_{DD}}$ = 50 V, $I_{_{DQ}}$ = 1.0 A, $P_{_{OUT}}$ = 47 dBm
Output Mismatch Stress ³	VSWR	-	-	10:1	Ψ	No damage at all phase angles, V $_{\rm DD}$ = 50 V, I $_{\rm DQ}$ = 1.0 A, P $_{\rm OUT}$ = 200 W Pulsed
Dynamic Characteristics						
Input Capacitance ⁷	C _{GS}	-	97	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz
Output Capacitance ⁷	C _{DS}	-	13.4	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz
Feedback Capacitance	C _{gd}	-	0.94	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz

Notes:

2

¹ Measured on wafer prior to packaging.

² Scaled from PCM data.

 3 Pulse Width = 100 μS , Duty Cycle = 10%

⁴ P_{SAT} is defined as I_{g} = 3 mA peak.

⁵ Measured in CGHV22200-AMP

⁶ Single Carrier WCDMA, 3GPP Test Model 1, 64 DPCH, 45% Clipping, PAR = 7.5 dB @ 0.01% Probability on CCDF.

⁷ Includes package and internal matching components.

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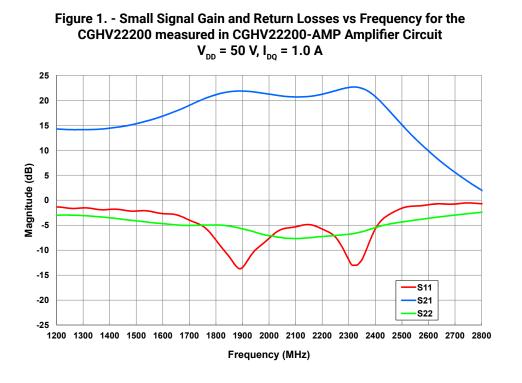
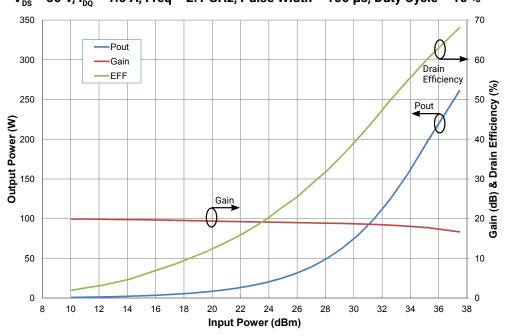


Figure 2. - Typical Gain and Drain Efficiency vs Input Power of the CGHV22200 measured in CGHV22200-AMP Amplifier Circuit. V_{ps} = 50 V, I_{po} = 1.0 A, Freq = 2.1 GHz, Pulse Width = 100 µs, Duty Cycle = 10 %



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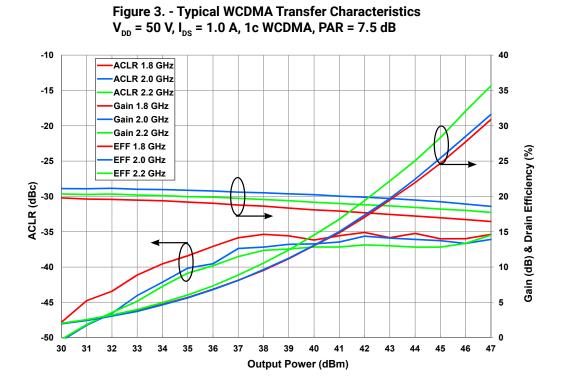
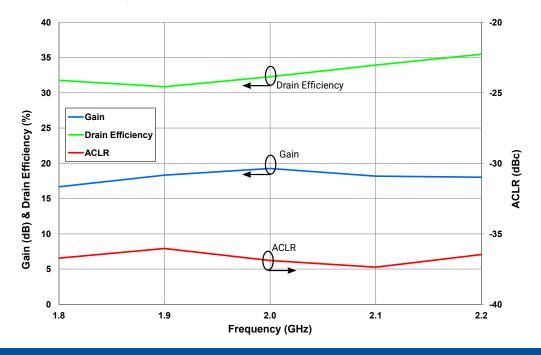


Figure 4. - Typical Gain, Drain Efficiency and ACLR vs Frequency of the CGHV22200 measured in CGHV22200-AMP Amplifier Circuit V_{DD} = 50 V, I_{DS} = 1.0 A, P_{AVE} = 50 W, 1c WCDMA, PAR = 7.5 dB

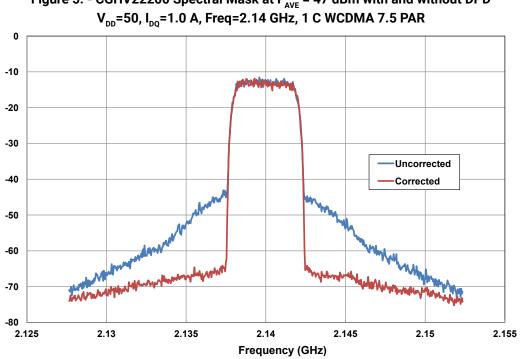


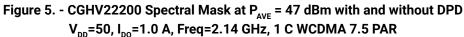
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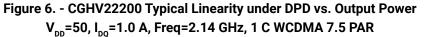
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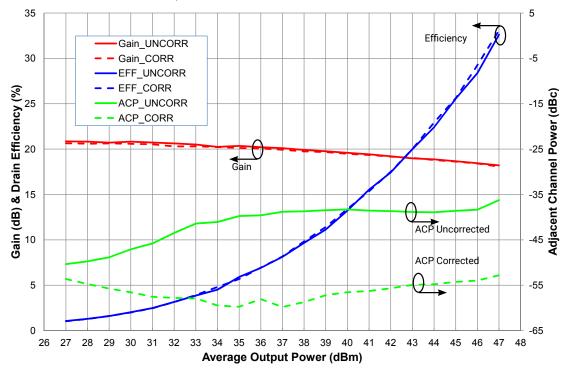
CGHV22200 Rev 2.0







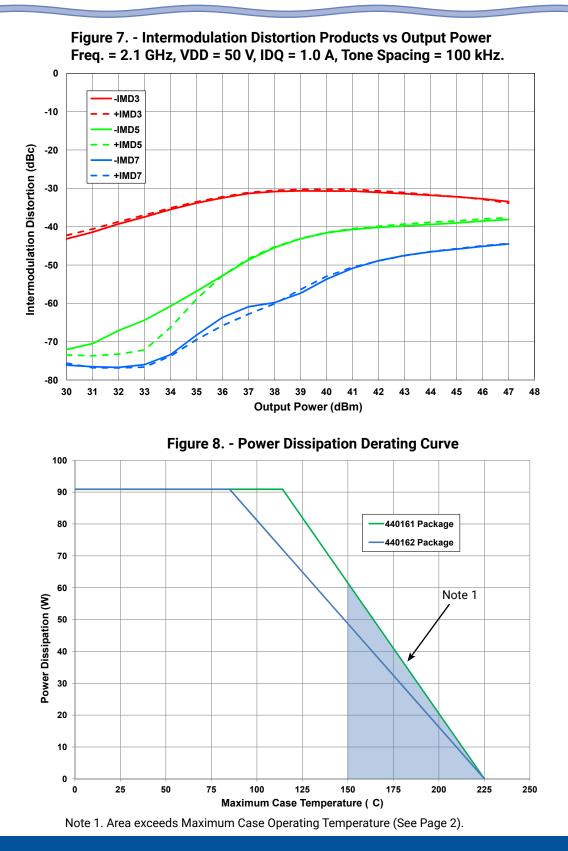




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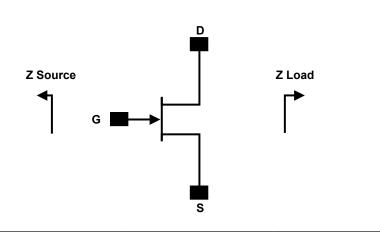
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CGHV22200 Rev 2.0



Source and Load Impedances



Frequency (MHz)	Z Source	Z Load
1800	10.6 - j7.3	2.7 + j0.6
1900	8.1 - j7.4	2.8 + j0.7
2000	6.1 - j6.6	2.9 + j0.8
2100	4.7 - j5.5	2.8 + j0.8
2200	3.7 - j4.3	2.6 + j0.8

Note¹: V_{DD} = 50 V, I_{DQ} = 1.0 A. In the 440162 package. Note²: Impedances are extracted from CGHV22200-AMP demonstration

circuit and are not source and load pull data derived from transistor.

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CGHV22200-AMP Demonstration Amplifier Circuit Bill of Materials

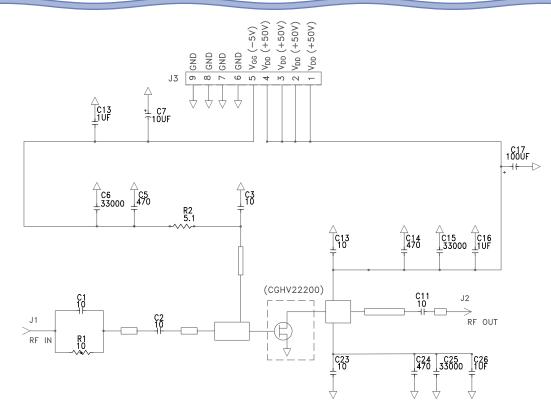
Designator	Description	Qty
R1	RES, 1/16 W, 0603, 1%, 10.0 OHMS	1
R2	RES, 1/16 W, 0603, 1%, 5.1 OHMS	1
C4, C14, C24	CAP, 470 pF, 5%, 100 V, 0603, X	3
C6,C16, C26	CAP, 1.0 UF, 100 V, 10%, x7R, 121	3
C17, C27	CAP, 100 UF, 20%, 160 V, ELEC	2
C7	CAP, 10 UF, 16 V, TANTALUM, 2312	1
C1, C2, C3, C13, C23	CAP, 10.0 pF, 5%, 0603, ATC	5
C5, C15, C25	CAP, 33000 pF, 0805, 100 V, X7R	3
C11	CAP, 10 pF, 5%, 250 V, 0805, A	1
J1, J2	CONN, N, FEM, W/.500 SMA FLNG	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
	PCB, CGHV22200F, RO4350,0.020" THK	1
	2-56 SOC HD SCREW 1/4 SS	4
	#2 SPLIT LOCKWASHER SS	4
	CGHV22200	1

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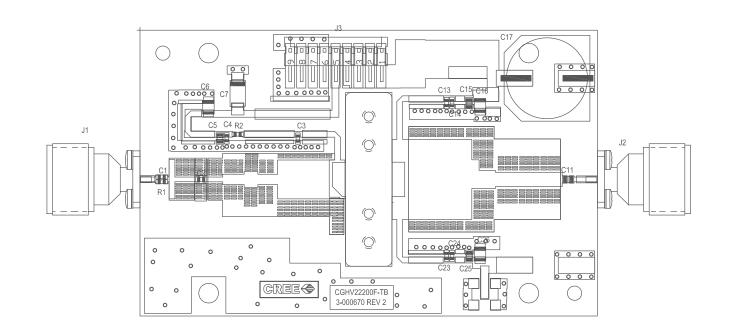
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CGHV22200-AMP Demonstration Amplifier Circuit Schematic



CGHV22200-AMP Demonstration Amplifier Circuit Outline



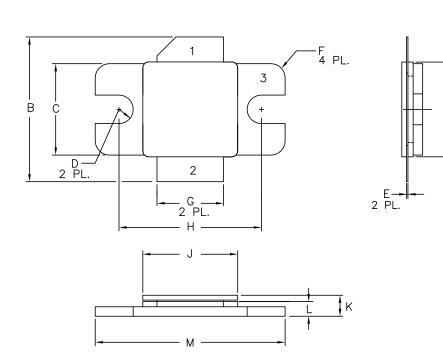
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Product Dimensions CGHV22200F (Package Type – 440162)



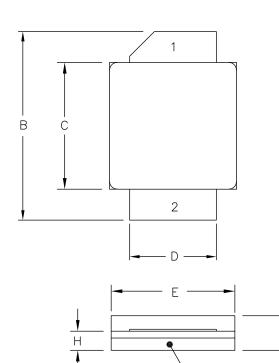
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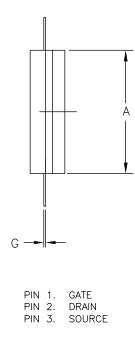
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

	INCHES		MILLIM	IETERS
DIM	MIN	MAX	MIN	МАХ
A	.395	.405	10.03	10.29
В	.580	.620	14.73	15.75
С	.380	.390	9.65	9.91
D	.055	.065	1.40	1.65
E	.004	.006	0.10	0.15
F	.055	.065	1.40	1.65
G	.275	.285	6.99	7.24
н	.595	.605	15.11	15.37
J	.395	.405	10.03	10.29
к	.129	.149	3.28	3.78
L	.053	.067	1.35	1.70
м	.795	.805	20.19	20.45

PIN 1. GATE PIN 2. DRAIN PIN 3. SOURCE

Product Dimensions CGHV22200P (Package Type - 440161)





NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- 4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
A	.395	.407	10.03	10.34
В	.594	.634	15.09	16.10
С	.395	.407	10.03	10.34
D	.275	.285	6.99	7.24
E	.395	.407	10.03	10.34
F	.129	.149	3.28	3.78
G	.004	.006	0.10	0.15
н	.057	.067	1.45	1.70

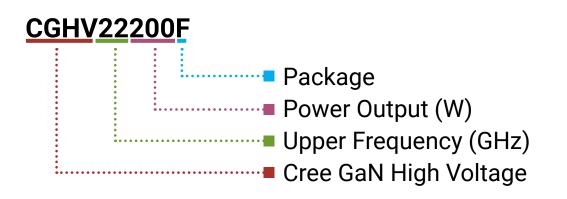
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F

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Part Number System



Value	Units
2.2	GHz
200	W
Flange	-
	2.2 200

Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
E	4
F	5
G	6
Н	7
J	8
К	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

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Product Ordering Information

Order Number CGHV22200F	Description GaN HEMT	Unit of Measure Each	Image
CGHV22200P	GaN HEMT	Each	CREE CREE CCHU22200P CCHU22200P CCHU22200P
CGHV22200-TB	Test board without GaN HEMT	Each	
CGHV22200F-AMP	Test board with GaN HEMT installed	Each	

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